

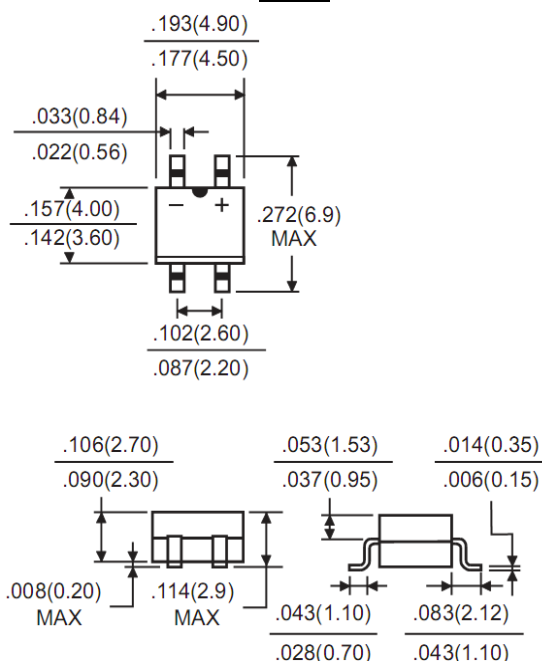
MBS

Features

- ✧ UL Recognized File # E-326243
- ✧ Ideal for printed circuit board
- ✧ Reliable low cost construction utilizing molded plastic technique
- ✧ High surge current capability
- ✧ High temperature soldering guaranteed: 260°C/10 seconds at 5 lbs., (2.3kg) tension
- ✧ Small size, simple installation
- ✧ Green compound with suffix "G" on packing code & prefix "G" on datecode

Mechanical Data

- ✧ Case: Molded plastic body
- ✧ Terminal: Leads solderable per MIL-STD-202 Method 208
- ✧ Weight: 0.123 grams


Dimensions in inches and (millimeters)
Marking Diagram


- MBSX = Specific Device Code
- G = Green Compound
- Y = Year
- M = Work Month

Maximum Ratings and Electrical Characteristics

Rating at 25 °C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	Symbol	MBS2	MBS4	MBS6	MBS8	MBS10	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	200	400	600	800	1000	V
Maximum Average Forward Rectified Current On glass-epoxy P.C.B. On aluminum substrate	$I_{F(AV)}$			0.5 0.8			A
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}			35			A
Maximum Instantaneous Forward Voltage (Note 1) @ 0.4A	V_F			1.0			V
Maximum DC Reverse Current at Rated DC Blocking Voltage $T_A=25\text{ }^\circ\text{C}$ $T_A=125\text{ }^\circ\text{C}$	I_R			5 100			μA
Rating of fusing ($t < 8.3\text{ms}$)	I^2T			5.08			A^2S
Typical Junction Capacitance Per Leg (Note 2)	C_j			13			pF
Typical Thermal Resistance (Note 3) (Note 4) (Note 3)	$R_{\theta JA}$ $R_{\theta JA}$ $R_{\theta JL}$			85 70 20			$^\circ\text{C/W}$
Operating Temperature Range	T_J			- 55 to + 150			$^\circ\text{C}$
Storage Temperature Range	T_{STG}			- 55 to + 150			$^\circ\text{C}$

Note 1: Pulse Test with PW=300 usec, 1% Duty Cycle

Note 2: Measure at 1.0MHz and Applied Reverse Voltage of 4.0 Volts D.C.

Note 3: On glass epoxy P.C.B. mounted on 0.05" x 0.05" (1.3mm x 1.3mm) pads

Note 4: On aluminum substrate P.C.B. with an area of 0.8" x 0.8" (20mm x 20mm) mounted on 0.05" x 0.05" (1.3mm x 1.3mm) solder pads

RATINGS AND CHARACTERISTIC CURVES (MBS2 THRU MBS10)

FIG. 1 MAXIMUM FORWARD CURRENT DERATING CURVE

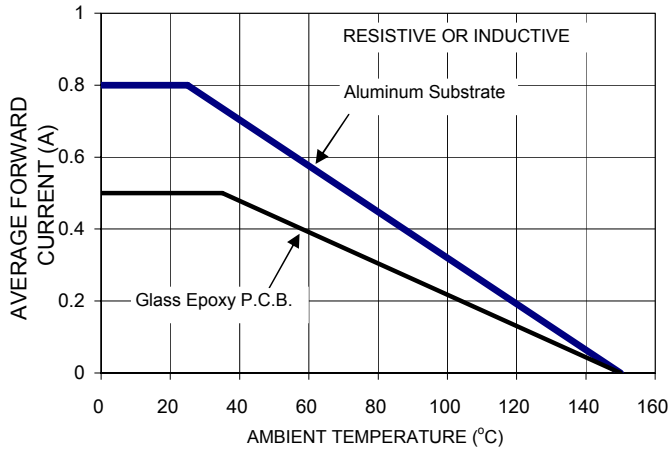


FIG. 2 TYPICAL REVERSE CHARACTERISTICS PER LEG

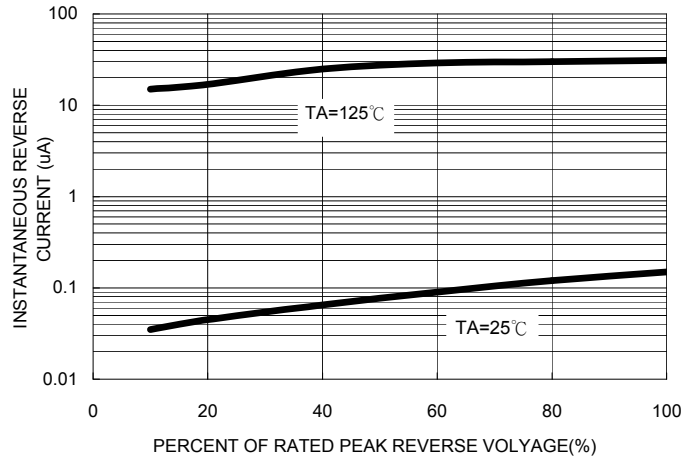


FIG. 3 MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT PER LEG

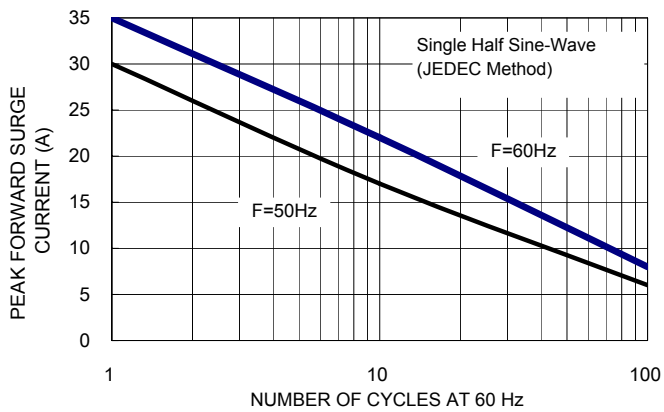


FIG. 4 TYPICAL JUNCTION CAPACITANCE PER LEG

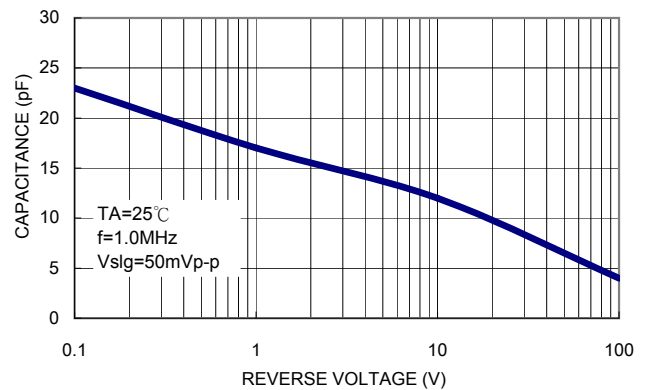


FIG. 5 TYPICAL FORWARD CHARACTERISTICS PER LEG

